

SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

CUSTOMER: (客戶): DATE :

(日期):2020-10-19

CATEGORY (品名) DESCRIPTION (型号)	-	ALUMINUM ELECTROLYTIC CAPACITORS HP 400V470 μ F(ϕ 30x35)
VERSION (版本)	:	01
Customer P/N	:	
SUPPLIER	:	

SUPPL	IER	CUS	ГOMER
PREPARED (拟定)	CHECKED (审核)	APPROVAL (批准)	SIGNATURE (签名)
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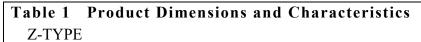
ELECTROLYTIC CAPACITOR SPECIFICATION HP SERIES

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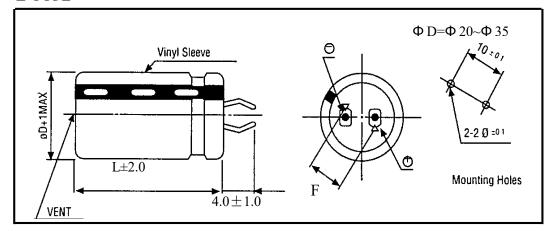


Table 1

I	No	SAMXON Part No.	WV (Vd c)	Cap. (µF)	Cap. tolerance	Temp. range(°C)	tan δ (120Hz, 20°C)	Leakage Current (µA,5min)	Max Ripple Current at 105°C 120Hz (A rms)	Load lifetime (Hrs)		nsion nm) F	Sleev e
	1	EHP477M2GP35SZ**P	400	470	-20%~+20%	-25~105	0.20	1301	1.64	2000	30X35	10 ± 1.0	PET

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1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

2. Pa	rt Nun	nbe	er Sy	ystem								
12	3	4	5 6	5 7		89	[10 11 12	2 131	4	1516	17
EG	S	1	0 5	5 IV		1 H		D11	т	C	SA	P
SERIE	ES C.	APA	CITAN	CE TO	L.	VOLTAGE	-	CASE SIZE	TYP		SAMXON	SLEEVE
											RODUCT LINE	
Series	Cap(MF	D)	Code	Tolerance (%) Code	Voltage (W.V.)	Code	Case Size	Feature (Code	SAMXON Product	Line
ESM EKF		.1	104	±5	J	2	0D	Diameter(Radial bulk	RR	For internal use onl	
ESS EKS						2.5	0E 0G	3 B 3.5 1 4 C 5 D	Ammo Tap		(The product lines we have H,A,B,C,D	
EGS		.22	224	±10	к	6.3	OJ	5 D 6.3 E	Anno Iap	ang	E,M or 0,1,2,3,4,5,5	
EKG EOM	- o	.33	334			8	0K 1A	6.3 E 8 F 10 G	2.0mm Pitch	Π		
EZM		.47	474	±15	L	12.5	1B	12.5 I 13 J 13.5 V	2.5mm Pitch	τυ		
EGF				. 00	м	16 20	1C 1D	14 4		-		
EGT			105	±20	N1	20	1D 1E	14.5 A 16 K 16.5 7	3.5mm Pitch	т∨	Sleeve Material	Code
EGE	2	.2	225	±30	N	30	11	18 L	5.0mm Pitch	тс	PET	P
EGC		.3	335			32	13 1V	185 8	Lead Cut & I	Form		
ERF		.3		-40 0	w	40	1G	20 M 22 N 25 O				
ERR	4	.7	475	-20 0	A	42 50	1M 1H	20 M 22 N 25 O 30 P 34 W 35 Q	СВ-Туре	СВ		
ERE	10		106			57	1L	35 Q 40 R	CE-Type	CE		
ERH EBD				-20 +10	С	63	1J	42 4 45 6	HE-Type	HE		
ERA	22	-	226	-20	~	71 75	1S 1T	51 S		\vdash		
ERC	33	- I	336	-20 +40	×	80	1K	63.5 T 76 U 80 8	KD-Type	KD		
ENP	47	·	476	-20 +50	s	85 90	1R 19	90 X 100 Z	FD-Type	FD		
ENH	;⊢	+	_			100	2A	Len.(mm) Code 4.5 45	EH-Type	EH		
ERY ELP	100	-	107	-10 0	В	120 125	20 2B	5 05				
EAP EQP EDP	220	-	227	-10 +20	v	150	25 2Z	7 07	PCB Term	nial		
ETP	330		337	-10		160 180	2C 2P	10.2 T2 11 11		sw		
EHP	1	-	_	+30	Q	200	2P 2D	11.5 1A 12 12 12.5 1B	Snap-in	sx		
EKP	470	<u> </u>	477	-10 +50	т	215	22	13 13		\vdash		
EFP ESP	2200	-	228	-5 +10	Е	220	2N 23	13.5 1C 20 20 25 25		sz		
EGP	22000		229		-	250	2E	295 211	Lug	SG		
EWR		-	_	-5 +15	F	275 300	2T 2I	30 30 31.5 3A 35 35		05		
EWT	33000	<u> </u>	339	-5 +20	G	310	2R	35 35 35.5 3E				
EWF	47000	-	479	+20		315 330	2F 2U	50 50 80 80		06		
EWH	100000		10T	+20	R	350	2V	100 1L 105 1K		Т5		
EWB VSS		-		0 +30	0	360	2X	110 1M 120 1N	Screw	тө		
VNS	150000	<u>۱</u>	15T	0	1	375 385	2Q 2Y	130 1P 140 1Q		\vdash		
VKM	220000	-	22T	+50	<u> </u>	400	2G	150 1R 155 1E		D5		
VNH VZS VRF	330000		33Т	+5 +15	z	420	2M 2W	160 1S 165 1F 170 1T		D6		
		-	_	+5 +20	D	500	2H	180 1U				
	100000	0	10M	+10	Y	550 600	25 26	190 1V 200 2L				
	150000	0	15M	+50		630	2J	210 2M				
	220000		2214	+10 +30	н			200 2L 215 2A 210 2M 220 2N 240 2Q 250 2R				
	220000	+	22M					260 2R 260 2S 270 2T				
	330000	0	33M					210 21				

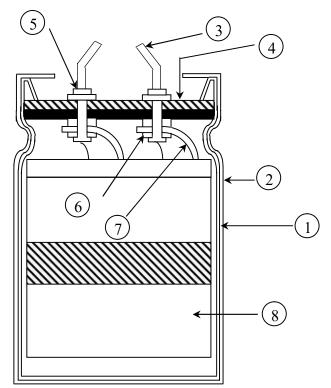
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3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material
1	Case	Aluminum case
2	Sleeve	PET
3	Terminal	Solder coated copper clad steel
4	Seal	Rubber-laminated bakelite
5	Rivet	Aluminum
6	Washer	Aluminum
7	Tab	Aluminum
8	Element	Aluminum foil & Electrolyte paper

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4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature $: 20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2

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Table 2 ITEM PERFORMANCE WV (V.DC) 10 16 25 35 50 63 80 100 160 Rated voltage 79 SV (V.DC) 13 20 32 44 63 100 125 200 (WV) 4.1 400 420 450 WV (V.DC) 180 200 220 250 315 350 500 225 270 365 400 450 470 500 550 SV (V.DC) 250 300 Surge voltage (SV) <Condition> Measuring Frequency $: 120Hz \pm 12Hz$ Nominal Measuring Voltage : Not more than 0.5Vrms capacitance Measuring Temperature $:20\pm2^{\circ}C$ 4.2 (Tolerance) <Criteria> Shall be within the specified capacitance tolerance <Condition> Connecting the capacitor with a protective resistor $(1k \,\Omega \pm 10 \,\Omega)$ in series for 5 minutes, and then, measure Leakage Current. Leakage 4.3 current <Criteria> Refer to table 1 <Condition> See 4.2, Norm Capacitance, for measuring frequency, voltage and temperature. <Criteria> Refer to table 1 4.4 tan δ Name Specification Sheet - HP Version 01 Page 7 STANDARD MANUAL

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Terminal strength	3 201 4 105	as terminal	damage. Time Time to Time to Time to Time to	reach thermal e reach thermal e reach thermal e reach thermal e	quilibrium quilibrium quilibrium		
	STEP Testing Tem 1 20: 2 -40(-2 3 20: 4 105 5 20:	± 2 25) ± 3 ± 2 5 ± 2	Time to Time to Time to Time to	reach thermal e reach thermal e reach thermal e	equilibrium equilibrium		
	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	± 2 25) ± 3 ± 2 5 ± 2	Time to Time to Time to Time to	reach thermal e reach thermal e reach thermal e	equilibrium equilibrium		
	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$25)\pm 3$ ± 2 5 ± 2	Time to Time to Time to	reach thermal e reach thermal e reach thermal e	equilibrium equilibrium		
	3 20 4 105 5 20	± 2 5 ± 2	Time to Time to	reach thermal e reach thermal e	quilibrium		
	4 105 5 20	5 ± 2	Time to	reach thermal e	-		
	5 20:						
		±2	I ime to	Time to reach thermal equilibrium			
			Time to reach thermal equilibrium				
characteristics	b. At-40℃ (-25℃), imped			-	e of the		
	<u> </u>	10~25	35 5	0 63~100	160~500		
	Z-25°C/Z+20°C	6	6 4	3	8		
	Z-40°C/Z+20°C	15	-	-			
	Capacitance, tan 0, and	mpedances	nan de mea	isureu at 120HZ			
	Temperature characteristics	value. a. In step 5, tan δ shall to Temperature characteristics b. At-40°C (-25°C), imper- following table: Working Voltage (V) Z-25°C/Z+20°C Z-40°C/Z+20°C	value.a. In step 5, tan δ shall be within the The leakage current shall not more characteristicsb. At-40 °C (-25 °C), impedance (Z) rate following table:Working Voltage (V)10~25Z-25 °C/Z+20 °C6Z-40 °C/Z+20 °C15	value.a. In step 5, tan δ shall be within the limit of Iter The leakage current shall not more than the st characteristicsb. At-40°C (-25°C), impedance (Z) ratio shall not following table:Working Voltage (V)10~25Z-25°C/Z+20°C6664Z-40°C/Z+20°C151515	a. In step 5, tan δ shall be within the limit of Item 4.4 The leakage current shall not more than the specified valueb. At-40°C (-25°C), impedance (Z) ratio shall not exceed the value following table:Working Voltage (V)10~25355063~100Z-25°C/Z+20°C6643		

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4.7	Load life test	temp 2000 work time <criter< b=""> The Lea Cap tan</criter<>	rding to IE0 erature of 1 +48/0 hours ing voltage) at atmosphe ia> characterist kage curren acitance Ch	$05^{\circ}C \pm 2$ s. (The su) Then the pric condi- <u>ic shall m</u> t	No.4.13 methods, 7 with DC bias volta of DC and ripple product should be tions. The result sho neet the following re Value in 4.3 shall Within $\pm 20\%$ of Not more than 200 There shall be no	age plus the rated peak voltage sha tested after16 ho ould meet the fol equirements. be satisfied initial value . 0% of the specific	all not exc ours recov lowing tal	rrent for eed the rated ering
4.8	Shelf life test	for 100 Follow allowe Next t voltag tested <crit< b=""> The o Lea Cap tan</crit<>	pacitors are 00+48/0 hou ving this pe ed to stabiliz hey shall be e applied for the character eria> characteristi kage curren acitance Ch δ pearance ark: If the c	ars. riod the o zed at roo e connecto or 30min. eristics. c shall m t hange	red with no voltage capacitors shall be no m temperature for 4 ed to a series limitin After which the ca eet the following re Value in 4.3 shall Within $\pm 15\%$ of Not more than 150 There shall be no are stored more tha eapply voltage through	removed from th \sim 8 hours. ng resistor(1k ± 1 pacitors shall be quirements. be satisfied initial value. 1% of the specifie leakage of electron n 1 year, the leak	e test cha 00 Ω) wit discharge d value. olyte cage curre	mber and be h D.C. rated ed, and then, nt may
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<Condition> Applied a surge voltage to the capacitor connected with a $(100 \ 0\pm 50)/C_R (k\Omega)$ resistor. The capacitor shall be submitted to 1000 cycles, each consisting of charge of 30 ± 5 s, followed discharge of 5 min 30S. The test temperature shall be $15 \sim 35^{\circ}$ C. C_R :Nominal Capacitance (μ F) <Criteria> Surge 4.9 Leakage current Not more than the specified value. test **Capacitance** Change Within $\pm 15\%$ of initial value. Not more than the specified value. $\tan \delta$ Appearance There shall be no leakage of electrolyte Attention: This test simulates over voltage at abnormal situation, and not be hypothesizing that over voltage is always applied. <Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : $10Hz \sim 55Hz$ Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute <Criteria> After the test, the following items shall be tested: No mechanical damage in terminal. No leakage of electrolyte or swelling of the case. The markings shall Appearance be legible. No intermittent contact, open or short circuit. Inner Vibration 4.10 No damage of tab terminals or electrodes. construction test Mounting method: The capacitor must be fixed in place with a bracket. Space < 1mm To be soldered Specification Sheet - HP Name Version 01 Page 10 STANDARD MANUAL

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<Condition> The capacitor shall be tested under the following conditions: Soldering temperature :245±3°C Dipping depth : 2mm Dipping speed : 25±2.5mm/s Dipping time : 3±0.5s Solderability 4.11 <Criteria> test A minimum of 95% of the surface being Coating quality immersed <Condition> Terminals of the capacitor shall be immersed into solder bath at $260\pm5\,^\circ\!\mathrm{C}\,\mathrm{for}10\pm1\mathrm{seconds}$ or 400 $\pm\,10\,^\circ\!\mathrm{C}\,\mathrm{for}3\,^{+1}_{-0}\,\mathrm{seconds}$ to 1.5~2.0mm from the body of capacitor. Then the capacitor shall be left under the normal temperature and normal humidity for 1~2 hours before measurement. <Criteria> Leakage current Not more than the specified value. Capacitance Change Within $\pm 10\%$ of initial value. $\tan\delta$ Resistance to Not more than the specified value. 4.12 solder heat There shall be no leakage of electrolyte Appearance test

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		oven, the condition ac	emperature	titor shall be placed in an
		(3)Rated high temper		30 ± 2 Minutes
		(1) to (3)=1 cycle, to	tal 5 cycle	
4.13	Change of temperature test	<criteria> The characteristic shall Leakage current tan δ Appearance</criteria>	meet the following requir Not more than the spe Not more than the spe There shall be no leak	cified value.
4.14	D	be exposed for 500 ± 8 $40\pm 2^{\circ}C$, the characteri <criteria></criteria> Leakage current	-4No.4.12methods, capac hours in an atmosphere of stic change shall meet the Not more than the specif	90~95%R H .at following requirement. řied value.
4.14	Damp heat	Humidity Test: According to IEC60384 be exposed for 500 ± 8 $40\pm 2^{\circ}C$, the characteri <criteria></criteria> Leakage current Capacitance Change tan δ	hours in an atmosphere of stic change shall meet the Not more than the specif Within $\pm 20\%$ of initial Not more than 120% of	90~95%R H .at following requirement. ied value. value . the specified value.
4.14		Humidity Test: According to IEC60384 be exposed for 500 ± 8 $40\pm 2^{\circ}C$, the characteri <criteria></criteria> Leakage current Capacitance Change	hours in an atmosphere of stic change shall meet the Not more than the specif Within $\pm 20\%$ of initial	90~95%R H .at following requirement. ied value. value . the specified value.

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		<condition> The following test only a D.C. test The capacitor is connect</condition>	ed with its pol	arity reverse		power source. Th
		a current selected from T	Table 2 is appl	ied.		
		<table 3=""></table>	a			
4.15	Vent test		Current (A)			
7.15	lest	22.4 or less Over 22.4	1 10			
		Over 22.4	10			
		<criteria> The vent shall operate w of pieces of the capacito</criteria>		ous condition	ns such as	flames or dispersi
		<condition> The maximum permissib at 120Hz and can be app Table-1 The combined value of D rated voltage and shall n Frequency Multipliers:</condition>	lied at maxim	um operatin l the peak A	g temperat	ure
Maximum permissible		Coefficient (Hz) Voltage (V)	60	120	1k	10k~50k
4.16	(ripple current)	10~100V	0.90	1.00	1.15	1.25
		160~250V	0.80	1.00	1.25	1.47
	315~500V	0.80	1.00	1.30	1.47	

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5.It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances				
	Cadmium and cadmium compounds				
Heavy metals	Lead and lead compounds				
Theavy metals	Mercury and mercury compounds				
	Hexavalent chromium compounds				
	Polychlorinated biphenyls (PCB)				
Chloinated	Polychlorinated naphthalenes (PCN)				
organic	Polychlorinated terphenyls (PCT)				
compounds	Short-chain chlorinated paraffins(SCCP)				
	Other chlorinated organic compounds				
D 1	Polybrominated biphenyls (PBB)				
Brominated organic	Polybrominated diphenylethers(PBDE) (including				
	decabromodiphenyl ether[DecaBDE])				
compounds	Other brominated organic compounds				
Tributyltin comp	oounds(TBT)				
Triphenyltin con	npounds(TPT)				
Asbestos					
Specific azo con	npounds				
Formaldehyde					
Polyvinyl chlorie	de (PVC) and PVC blevds				
Beryllium oxide					
Beryllium copp	er				
Specific phthala	tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)				
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)				
Perfluorooctane	sulfonates (PFOS)				
Specific Benzoti	iazole				

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Attachment: Application Guidelines

1.Circuit Design

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at 20° C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
 - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
 - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
 - a) At higher frequencies capacitance and impedance decrease while tan δ increases.
 - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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(1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

(3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

- (2) Capacitors Connected in Series Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.
- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

(2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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 (4) Clearance for Case Mounted Pressure Relief vents Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows. φ 6.3~ φ 16mm:2mm minimum, φ 18~ φ 35mm:3mm minimum, φ 40mm or greater:5mm minimum.
(5) Clearance for Seal Mounted Pressure Relief VentsA hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.
(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
 (7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.
 (8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.
 1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows. (1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths (3) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.
1.7 The Product characteristic should take the sample as the standard.
 1.8 Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about $1k \Omega$.
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately $1k \Omega$.
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- * (1) Verify the correct capacitance and rated voltage of the capacitor.
- * (2) Verify the correct polarity of the capacitor before inserting.
- * (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
 (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400 $^\circ$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150° C for a maximum time of 2 minutes.

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2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- * (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60° C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- * (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- . Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- * (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- * (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

3. Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- * (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- * (2) Direct contact with water, salt water, or oil.
- * (3) High humidity conditions where water could condense on the capacitor.

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- * (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- * (5) Exposure to ozone, radiation, or ultraviolet rays.
- * (6) Vibration and shock conditions exceeding specified requirements.

3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water. If electrolyte or gas is ingested by month, gargle with water. If electrolyte contacts the skin, wash with soap and water.

5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a 1000Ω , current limiting resistor for a time period of 30 minutes .

5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

- * Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.
- * Dispose of as solid waste.

NOTE: Local laws may have specific disposal requirements, which must be followed.

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